

< C band internally matched power GaAs FET >

MGFC40V5258

5.2 - 5.8 GHz BAND / 10W

DESCRIPTION

The MGFC40V5258 is an internally impedance-matched GaAs power FET especially designed for use in 5.2 - 5.8 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

Class A operation

Internally matched to 50(ohm) system

• High output power

P1dB=10W (TYP.) @f=5.2 - 5.8GHz

• High power gain

GLP=10dB (TYP.) @f=5.2 - 5.8GHz

• High power added efficiency

P.A.E.=32% (TYP.) @f=5.2 - 5.8GHz

APPLICATION

• item 01: 5.2 - 5.8 GHz band power amplifier

• item 51: 5.2 - 5.8 GHz band digital radio communication

QUALITY

• IG

RECOMMENDED BIAS CONDITIONS

• VDS=10V • ID=2.4A • RG=50ohm

Absolute maximum ratings (Ta=25°C)

| Symbol | Parameter | Ratings | Unit | | | | |
|--------------|----------------------------------|-------------|------|--|--|--|--|
| VGDO | Gate to drain breakdown voltage | -15 | V | | | | |
| VGSO | Gate to source breakdown voltage | -15 | V | | | | |
| ID | Drain current | 7.5 | Α | | | | |
| IGR | Reverse gate current | -20 | mA | | | | |
| IGF | Forward gate current | 42 | mA | | | | |
| PT *1 | Total power dissipation | 42.8 | W | | | | |
| Tch | Cannel temperature | 175 | °C | | | | |
| Tstg | Storage temperature | -65 to +175 | °C | | | | |
| *1 : Tc=25°C | | | | | | | |

OUTLINE DRAWING Unit: millimeters (inches) 24+/-0.3 R1.25 R1.2 (2) (3) 20.4+/-0.2 13.4 (1): GATE (2): SOURCE (FLANGE) **GF-18** (3): DRAIN

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Electrical characteristics (Ta=25°C)

| Symbol | Parameter | Test conditions | Limits | | Unit | |
|--------------|--------------------------------------|-------------------------|--------|------|------|------|
| | | | Min. | Тур. | Max. | |
| IDSS | Saturated drain current | VDS=3V,VGS=0V | - | 4.5 | 6 | Α |
| gm | Transconductance | VDS=3V,ID=2.2A | - | 2 | - | S |
| VGS(off) | Gate to source cut-off voltage | VDS=3V,ID=40mA | -2 | -3 | -4 | V |
| P1dB | Output power at 1dB gain compression | VDS=10V,ID(RF off)=2.4A | 39.5 | 40.5 | - | dBm |
| GLP | Linear Power Gain | f=5.2 – 5.8GHz | 8 | 10 | - | dB |
| ID | Drain current | | - | 2.4 | - | Α |
| P.A.E. | Power added efficiency | | - | 32 | - | % |
| Rth(ch-c) *3 | Thermal resistance |] | - | - | 3.5 | °C/W |

^{*2 :}item -51 ,2 tone test,Po=29dBm Single Carrier Level ,f=5.0GHz,delta f=10MHz

^{*3:} Channel-case

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